### 1. High Frequency Use (Non Magnetic Core) RF, RE, ND, NC, NA

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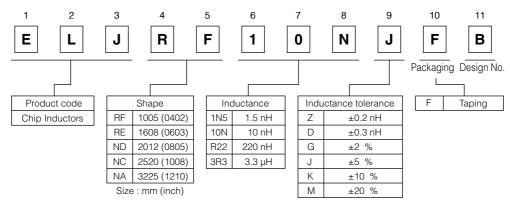
### Features

- High frequency capability due to its non magnetic core.
- Capable of being Re-flow or flow soldered.
- Wide line-up from 1005 to 3225 case sizes.
- Good for mounting.
- RoHS compliant

### Recommended Applications

• RF circuitry for cellular phones and wireless communication equipment.

### Explanation of Part Numbers



### Storage Conditions

Package : Normal temperature (-5 to 35 °C), normal humidity (85 %RH max.), shall not be exposed to direct sunlight and harmful gases and care should be taken so as not to cause dew.
Operating Temperature : -40 to +85 °C (RF, RE)

-20 to +85 °C (ND, NC, NA)

### Storage Period

• Solderability may be reduced due to the conditions of high temperature and high humidity which causes the oxidation of tin-plated terminals. Even if storage conditions are within specified limits, solderability may be reduced with the passage of time. Therefore, please control the storage conditions and try to use the product within 6 months of receipt.

### Packaging Methods, Soldering Conditions and Safety Precautions

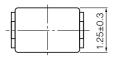
Please see Data Files.

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use. Should a safety concern arise regarding this product, please be sure to contact us immediately. 01 Sep. 2012

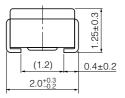
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■ ND Type 2012 (0805)

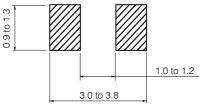
• Dimensions in mm (not to scale)







• Recommended Land Pattern in mm (not to scale)



### Standard Packing Quantity

• 3000 pcs./Reel

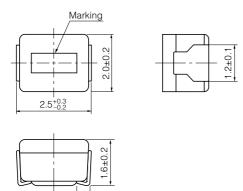
### Standard Parts

		Inductance		(	Ç	SRF *1	<b>B</b> DC *2	DC Current
Part No.	(nH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	(MHz) min.	$(\Omega)$ max.	(mA) max.
ELJND10NDF	10			10		3300	0.18	540
ELJND12N□F	12			10		3300	0.24	535
ELJND15NDF	15	K:±10 %			]	3000	0.24	520
ELJND18N□F	18	IX. ±10 /⁄o		12		3000	0.29	480
ELJND22N□F	22					2600	0.29	465
ELJND27N□F	27		100		100	2500	0.34	455
ELJND33NDF	33		100		100	2050	0.39	395
ELJND39N□F	39					2000	0.41	390
ELJND47N□F	47			15		1650	0.46	385
ELJND56N□F	56					1550	0.51	360
ELJND68N□F	68					1450	0.57	340
ELJND82N□F	82					1100	0.63	330
ELJNDR10□F	100			8		800	0.86	285
ELJNDR12□F	120			8	-	600	0.99	275
ELJNDR15	150	K : ±10 %				600	1.47	230
ELJNDR18□F	180	or				600	1.61	195
ELJNDR22 F	220	J:±5%				500	1.84	170
ELJNDR27 F	270		25.2		25.2	300	1.95	165
ELJNDR33	330		20.2	10	20.2	200	2.16	160
ELJNDR39	390			10		150	2.37	150
ELJNDR47□F	470					150	2.56	145
ELJNDR56□F	560	]				100	2.69	140
ELJNDR68□F	680					100	3.02	130
ELJNDR82	820	]				80	3.38	125
ELJND1R00F	1000		7.96	8	7.96	80	3.88	120

\*1 : Self Resonant Frequency \*2 : DC Resistance

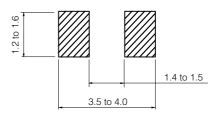
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- NC Type 2520 (1008)
- Dimensions in mm (not to scale)



0.4±0.2

• Recommended Land Pattern in mm (not to scale)



Standard	l Packing	Quantity
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• 2000 pcs./Reel

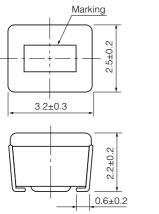
### Standard Parts

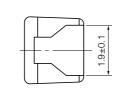
		Inductance		(	Q		RDC *2	DC Current
Part No.	(nH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	SRF *1 (MHz) min.	(Ω) max.	(mA) max.
ELJNC10N□F	10					2500	0.32	280
ELJNC12N□F	12			10		2200	0.34	270
ELJNC15N□F	15	K:±10 %		10		1800	0.38	255
ELJNC18N□F	18	$\int \mathbf{K} \cdot \pm 10\%$				1550	0.40	250
ELJNC22N□F	22				]	1350	0.43	240
ELJNC27N□F	27		- 100		100	1150	0.47	230
ELJNC33N□F	33				100	1000	0.51	220
ELJNC39N□F	39			15		890	0.55	215
ELJNC47N□F	47					770	0.59	205
ELJNC56N□F	56					670	0.63	200
ELJNC68N□F	68					590	0.68	190
ELJNC82N□F	82					520	0.73	185
ELJNCR10□F	100					460	0.80	175
ELJNCR12□F	120	K : ±10 %				400	0.87	170
ELJNCR15□F	150					340	0.98	160
ELJNCR18□F	180	- or				300	1.05	155
ELJNCR22□F	220	J:±5%				260	1.15	145
ELJNCR27□F	270		25.2	10	25.2	230	1.25	140
ELJNCR33□F	330		20.2	10	20.2	200	1.37	135
ELJNCR39□F	390					180	1.47	130
ELJNCR47□F	470	7				160	1.58	125
ELJNCR56□F	560	]				145	1.70	120
ELJNCR68□F	680	7				130	1.85	110
ELJNCR82□F	820	1				100	2.10	100

□ : Symbol of Tolerance **\*1** : Self Resonant Frequency **\*2** : DC Resistance

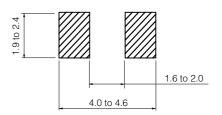
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- NA Type 3225 (1210)
- Dimensions in mm (not to scale)





Recommended Land Pattern in mm (not to scale)



### Standard Packing Quantity

• 2000 pcs./Reel

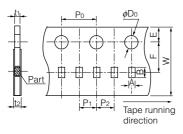
### ■ Standard Parts

		Inductance		(	2	SRF *1	RDC *2	DC Current
Part No.	(nH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	(MHz) min.	( <b>Ω</b> ) max.	(mA) max.
ELJNA47N□F	47					680	0.20	450
ELJNA56N□F	56					600	0.22	420
ELJNA68N□F	68		100		100	540	0.25	400
ELJNA82N□F	82	M : ±20 %				500	0.27	380
ELJNAR10□F	100	IVI . ±20 /0				450	0.30	360
ELJNAR12□F	120					400	0.67	240
ELJNAR15□F	150		25.2	10		350	0.72	230
ELJNAR18□F	180					320	0.81	220
ELJNAR22□F	220			10		280	0.90	210
ELJNAR27□F	270				25.2	250	1.0	200
ELJNAR33□F	330	K : ±10 %				220	1.1	190
ELJNAR39□F	390	or				200	1.2	180
ELJNAR47□F	470					180	1.4	175
ELJNAR56□F	560	- J:±5%				160	1.5	170
ELJNAR68□F	680					150	1.7	155
ELJNAR82□F	820					135	1.9	145
ELJNA1R0□F	1000					120	2.1	125
ELJNA1R2□F	1200		1			110	2.3	120
ELJNA1R5□F	1500		I			95	2.7	115
ELJNA1R8□F	1800					85	3.0	110
ELJNA2R2□F	2200					80	3.2	110
ELJNA2R7□F	2700	J:±5%		13	7.96	70	3.6	105
ELJNA3R3□F	3300	U. ± J /⁄		10	1.30	62	4.2	100
ELJNA3R9□F	3900					57	4.4	95
ELJNA4R7□F	4700					52	7.7	70
ELJNA5R6□F	5600					46	8.7	65
ELJNA6R8□F	6800					42	10	60
ELJNA8R2□F	8200					38	11	60

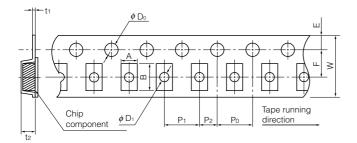
□ : Symbol of Tolerance **\*1** : Self Resonant Frequency **\*2** : DC Resistance

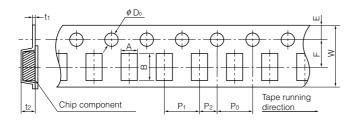
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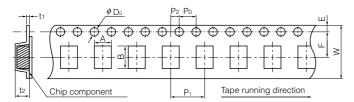
- Packaging Methods (Taping)
- Punched Carrier Tape Dimensions in mm (not to scale)



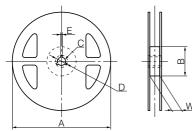
### • Embossed Carrier Tape Dimensions in mm (not to scale)







### • Taping Reel Dimensions in mm (not to scale)



### Standard Packing Quantity/Reel

Quantity	Quantity
RF, QF, PF	10000 pcs.
RE, QE, PE, ND	3000 pcs.
NC, FC, PC, LC, SC	2000 pcs.
NA, FA, PA, LA, SA, EA, DA	2000 pcs.
FB, PB	500 pcs.

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	А	В	W	E	F	P1
RF, QF, PF	0.71	1.21	8.0	1.75	3.5	2.0
	P <sub>2</sub>	P₀	$\phi_{D^0}$	t1	t2	
RF, QF, PF	2.0	4.0	<i>ф</i> 1.5	0.7 max.	1.0 max.	

### ● Type □E, Type ND, Type □C

- ,	<b>7</b> 1	, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	-			
	А	В	W	E	F	P1
RE, QE, PE	1.0	1.8	8.0	1.75	3.5	4.0
ND	1.45	2.25	8.0	1.75	3.5	4.0
NC, FC, PC, LC, SC	2.40	2.90	8.0	1.75	3.5	4.0
	P <sub>2</sub>	Po	¢D₀	$\phi D_1$	t1	t2
RE, QE, PE	2.0	4.0	<i>¢</i> 1.5	<i>\$</i> 0.6	(0.27)	1.2
ND	2.0	4.0	<i>¢</i> 1.5	<i>¢</i> 1.0	(0.25)	1.55
NB	2.0	U	71.0	/ 1.0	(0.20)	1.00

● Type □A

•						
	А	В	W	E	F	P1
NA, FA, PA, LA, SA, EA, DA	2.80	3.60	8.0	1.75	3.5	4.0
	P <sub>2</sub>	Po	$\phi_{D^0}$	t1	t2	
NA, FA, PA, LA, SA, EA, DA	2.0	4.0	<i>¢</i> 1.5	(0.25)	2.40	

### ) Туре ⊟В

	А	В	W	E	F	P1
FB, PB	3.60	4.90	12.0	1.75	5.5	8.0
	P <sub>2</sub>	Po	¢D₀	t1	t2	

Parts Types	А	В	С	D	E	W
RF, QF, PF, RE, QE, PE, ND, NC, FC, PC, LC, SC, NA, FA, PA, LA, SA, EA, DA	180	60	13	21	2	9
FB, PB	180	60	13	21	2	13

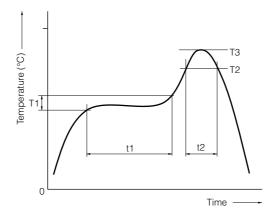
Under conditions of high temperature and humidity deterioration of the taping and packaging may be accelerated.

Please carefully control storage conditions and use the product within 6 months of receipt.

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### **Soldering Conditions**

Reflow soldering conditions



### Pb free solder recommended temperature profile

Туре	Preł	neat	Soldering Pea		Peak Ten	Peak Temperature		
туре	T1 [°C]	t1 [s]	T2 [°C]	t2 [s]	Т3	T3 Limit	Reflow	
□F	150 to 180	60 to 120	230 °C	40 max.	250 °C, 10 s	260 °C, 10 s	2 times max.	
DE	150 to 180	60 to 120	230 °C	40 max.	250 °C, 10 s	260 °C, 10 s	2 times max.	
	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.	
	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.	
□A	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.	
□B	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.	

### Flow soldering conditions

Preheat: 130 to 150 °C, 60 to 180 s, Soldering: 260 °C, 5 s max.

### Notes

- Solderability may be reduced due to the conditions of high temperature and high humidity which causes the oxidation of tin-plated terminals. Even if storage conditions are within specified limits, solderability may be reduced with the passage of time. Therefore, please control the storage conditions and try to use the product within 6 months of receipt.
- In case the product has been stored for a period longer than 6 months, use the product only after confirmation of its solderability.

### ▲ Safety Precautions

(Common precautions for Chip Inductors)

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate their operations when installed in your products.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other significant damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention equipment.
- \* Systems equipped with a protection circuit and a protection device
- \* Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault

### $\triangle$ Precautions for use

### 1. Operation range and environments

- (1) These products are designed and manufactured for general and standard use in general electronic equipment (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment)
- (2) These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
  - In liquid, such as water, oil, chemicals, or organic solvent
  - In direct sunlight, outdoors, or in dust
  - In salty air or air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>2</sub>
  - In an environment where these products cause dew condensation

### 2. Handling

- (1) Do not bring magnets or magnetized materials close to the product. The influence of their magnetic field can change the inductance value.
- ② Do not apply strong mechanical shocks by either dropping or collision with other parts. Excessive schock can damage the part.

### 3. Land pattern design

- ① Please refer to the recommended land pattern for each type shown on the datasheet.
- ② Avoid placing the chip inductor on any metal pattern except the recommended land pattern because a drop of Q and mutual conductance may occur.
- ③ In case of flow soldering, venting of soldering flux gases should be made for high density assemblies to get a good solder connection.
- ④ In case of reflow soldering, consider the layout because taller components close to chip inductor tend to block thermal conduction.

### 4. Mounting

- (1) In general, magnetic and electric characteristics of ferrite cores can be changed by applying excessively strong force. Placement force should not exceed 20 N.
- (2) Do not bend or twist the PWB after mounting the part.

### 5. Cleaning

- ① Do not use acid or alkali agents. Some cleaning solvents may damage the part.
- Confirm by testing the reliability in advance of mass production.
- (2) If Ultrasonic cleaning is used, please confirm the reliability in advance.

It is possible that combined resonance of component and PWB and cavitation can cause an abnormal vibration mode to exist causing damage.

### 6. Caution about applying excessive current

The rated current is defined as the smaller value of either the current value when the inductance drops 10 % down from the initial point or the current value when the average temperature of coil inside rises 20 °C up from the initial point. Do not operate product over the specific max. current.

### <Package markings>

Package markings include the product number, quantity, and country of origin. In principle, the country of origin should be indicated in English.

### Chip Inductors





Ceramic Core/Laser-Cut and wire wound type chip inductors for automatic and high-density mounting Wide variation product line-up correspond to various needs

### Recommended Applications

• Cellular phones, wireless communication equipment (W-LAN, Bluetooth), various modules, HIC, TV, VTR, PC & peripherals, DVD, DSC, STB.

#### Size : mm (inch) Non wound Wire wound Technology Case Size 1608 Size 2012 Size 1005 Size 2520 Size 3225 Size 4532 Usage (1812) (0402) (0603)(0805)(1008)(1210)ELJNA ELJRF ELJRE ELJND **ELJNC** High Freq. Use چې ø 0 1.0-220 nH 10-1000 nH 10-820 nH 47-8200 nH 1.0-100 nH ELJQF ELJQE High Freq. ð ð High-Q 1.0-39 nH 2.2-56 nH **ELJFC ELJFA** ELJFB General Use 0.22–1000 µH 0.22-100 µH 0.22-220 µH ELJPF ELJPE ELJPC/PC□3 ELJPA/PA 2 ELJPB ELJLC ELJLA **High Power** 2.2-10 nH 2.2-22 nH 1.0-330 µH 10-220 uH 1.0-33 µH ELJSC **ELJSA** Magnetically Shielded 27-100 µH 10-270 µH **ELJEA** Low DC Resistance 1.0–330 µH ELJDA/ELJFA Signal **Processing Use** (Low Distortion Type) 39–100 µH

### Inductors · Selection Guide

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